

Digital Microelectronic Circuits (361-1-3021)

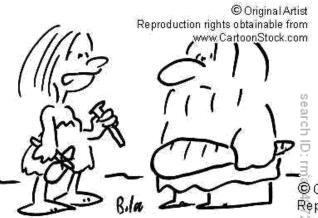
Presented by: Mr. Adam Teman

Appendix to Lecture 2:

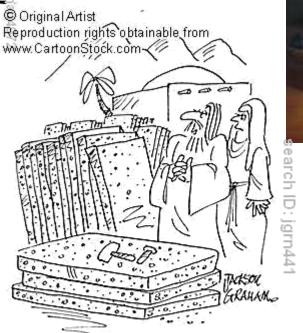
Manufacturing Integrated Circuits



Motivation



"I'm exhausted — I just spent all morning writing a note to the milkman!"



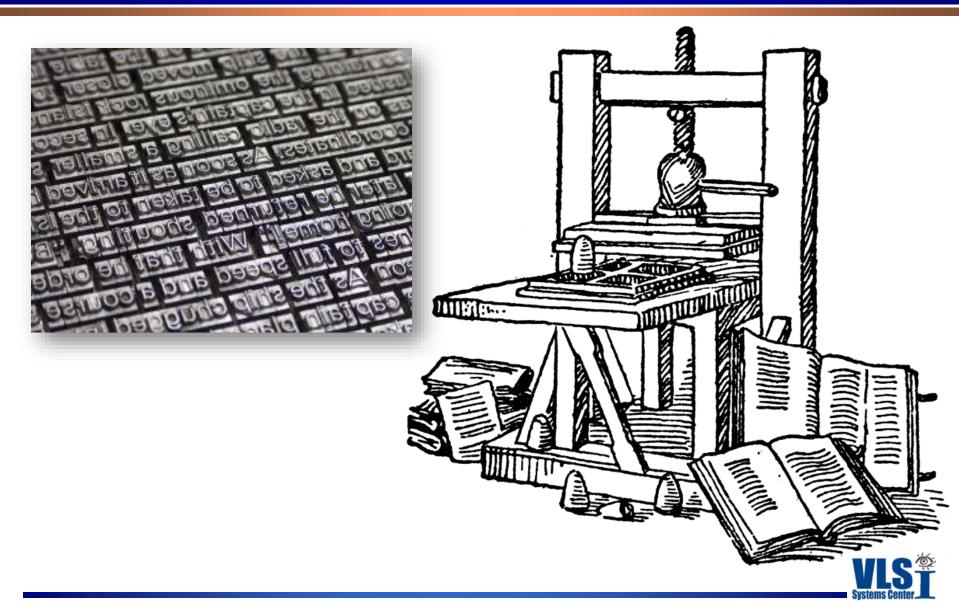


1~3 Years...

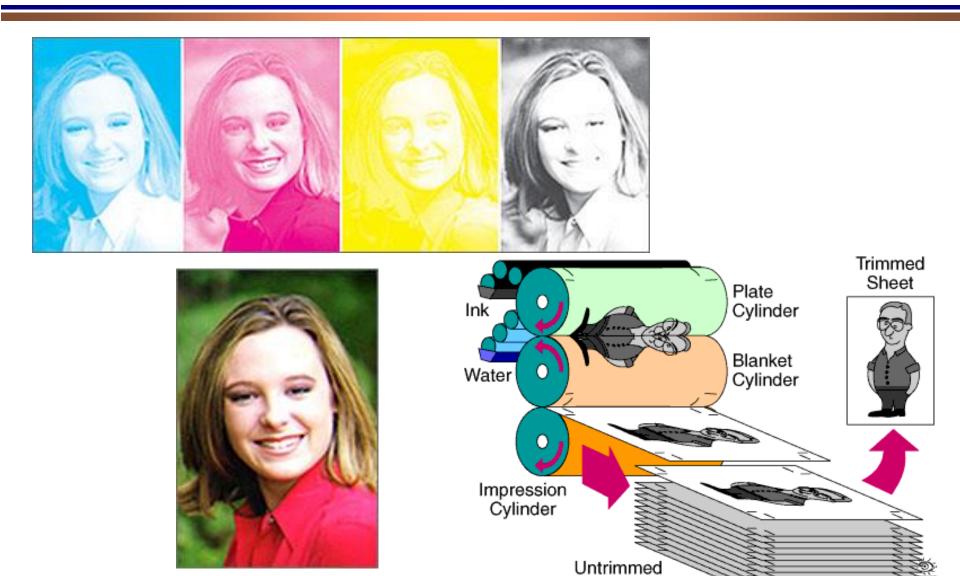
I'VE DECIDED TO WRITE A NOVEL ".



Solution

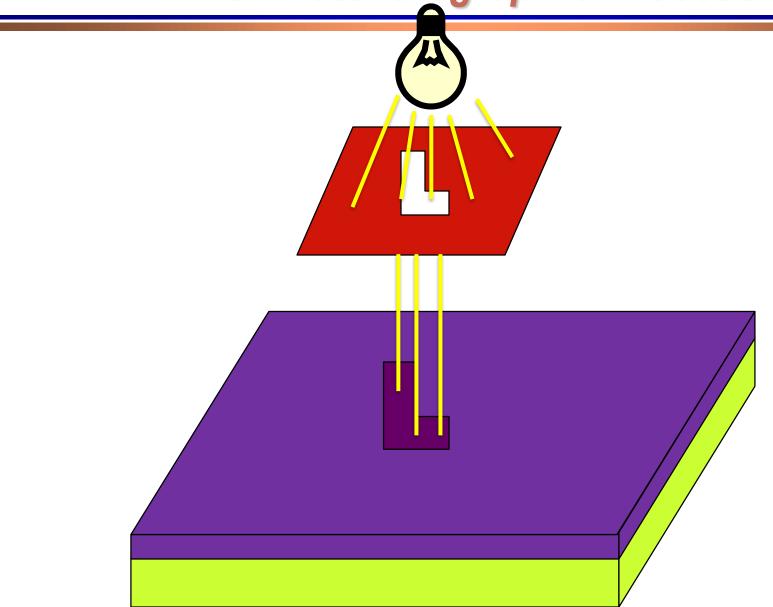


The Printing Process

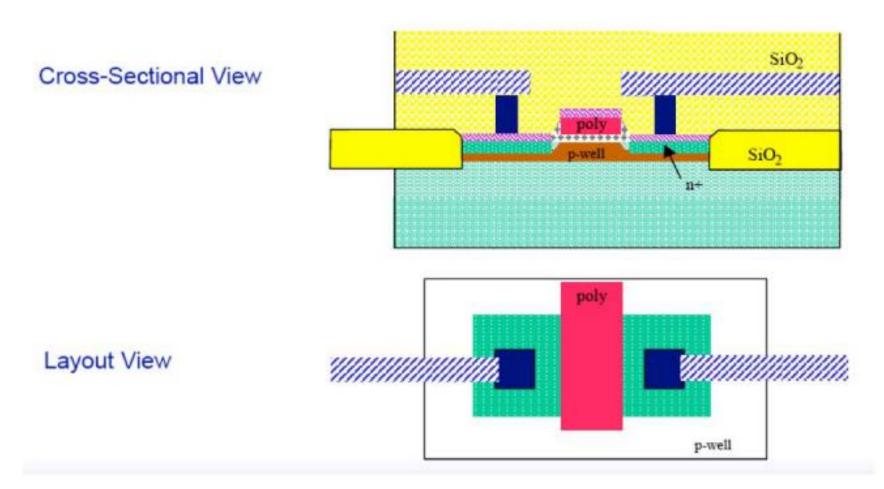


Sheets

The Photolithographic Process



Transistor Layout





CMOS Process/Transistors



Basic Process Flow

Lightly Doped Wafer

Grow Field Oxide

Define Wells

Grow Gate Oxide

Deposit Poly Gate

Etch Gates

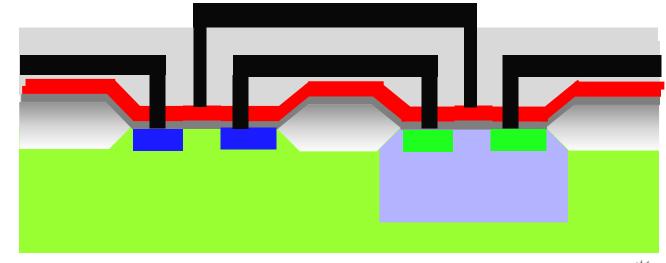
Implant Source/Drain

Deposit Isolation
Oxide and Contacts

Deposit Metal 1

Deposit Isolation
Oxide and Via 1

Deposit Metal 2



Photos

